

1761468-1 ✓ ACTIVE

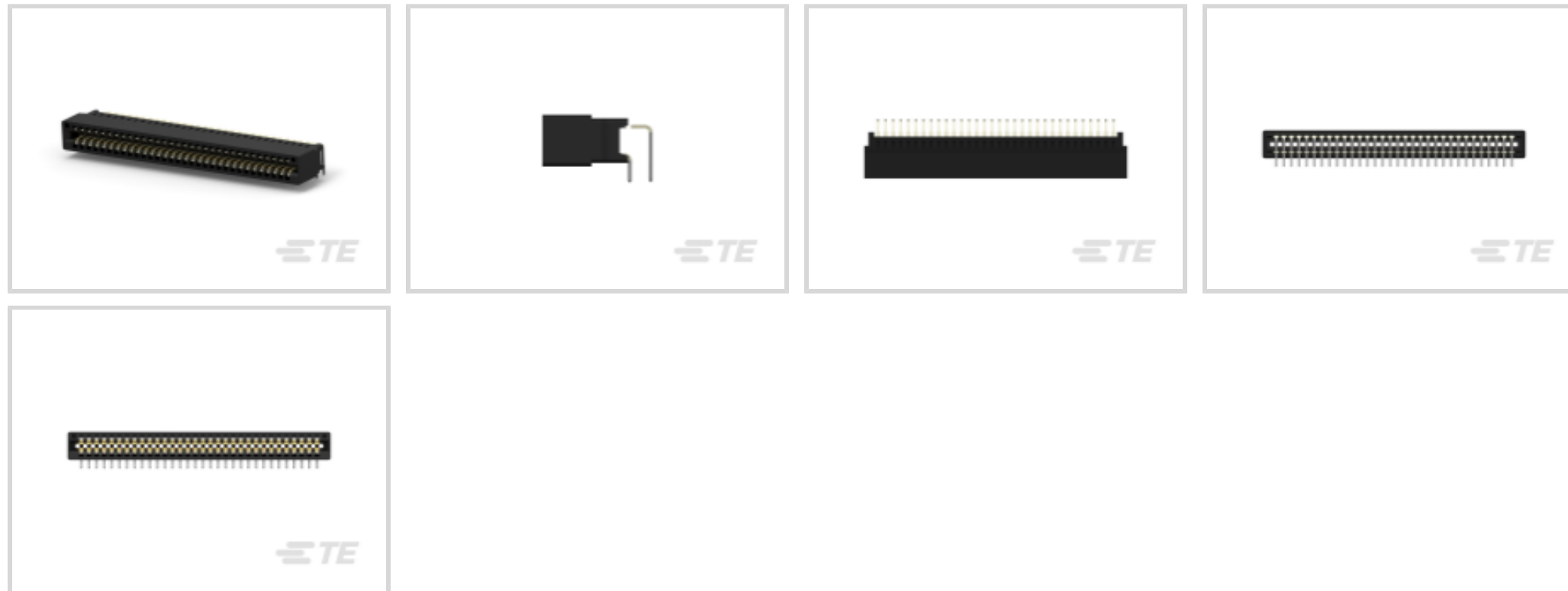
TE Internal #: 1761468-1

Board-to-Board Card Edge Power Connector, 64 Position, 2.54 mm
[.1 in] Centerline, Power & Signal, 64 Power Positions, 0 Signal
Positions

[View on TE.com >](#)



Connectors > PCB Connectors > Card Edge Connectors > Card Edge Power Connectors



Connector System: **Board-to-Board**

Number of Positions: **64**

Centerline (Pitch): **2.54 mm [.1 in]**

Contact Current Rating (Max): **3 A, 6.05 A**

Circuit Application: **Power & Signal**

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Connector Mates With	Printed Circuit Board
Connector & Housing Type	Receptacle
Connector System	Board-to-Board

Configuration Features

Keying & Polarized Position Locations	0
PCB Mount Orientation	Right Angle
Number of Positions	64
Number of Power Positions	64
Number of Signal Positions	0
Number of Dual Positions	32

Electrical Characteristics

Operating Voltage	400 V
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Body Features



Primary Product Color	Black
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Contact Features

Contact Underplating Material	Nickel
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PCB Contact Termination Area Plating Material Finish	Matte
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Contact Mating Area Plating Material Thickness	.38 μm [15 μin]
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PCB Contact Termination Area Plating Material Thickness	2.54 μm [100 μin]
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Contact Base Material	Copper Alloy
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PCB Contact Termination Area Plating Material	Tin
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Contact Type	Socket
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Contact Current Rating (Max)	3 A, 6.05 A
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Contact Mating Area Plating Material	Gold (Au)
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Termination Features

Termination Post & Tail Length	3.56 mm[.14 in]
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Termination Method to PCB	Through Hole - Solder
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Mechanical Attachment

Connector Mounting Type	Board Mount
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PCB Mount Retention	Without
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Mating Retention	Without
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Mating Alignment Type	Keyed
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Mating Alignment	With
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PCB Mount Alignment	Without
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Housing Features

Housing Material	Polyester GF
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Centerline (Pitch)	2.54 mm[.1 in]
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Dimensions

Card Slot Depth	7.49 mm
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Row-to-Row Spacing	3.81 mm[.149 in]
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Connector Height	15.49 mm[.61 in]
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Power Contact Centerline	2.54 mm[.1 in]
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Usage Conditions

Operating Temperature Range	-55 – 105 $^{\circ}\text{C}$ [-67 – 221 $^{\circ}\text{F}$]
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Operation/Application



Circuit Application	Power & Signal
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Packaging Features

Packaging Quantity	78
Packaging Method	Tray

Other

Position Locations Omitted	0
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Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

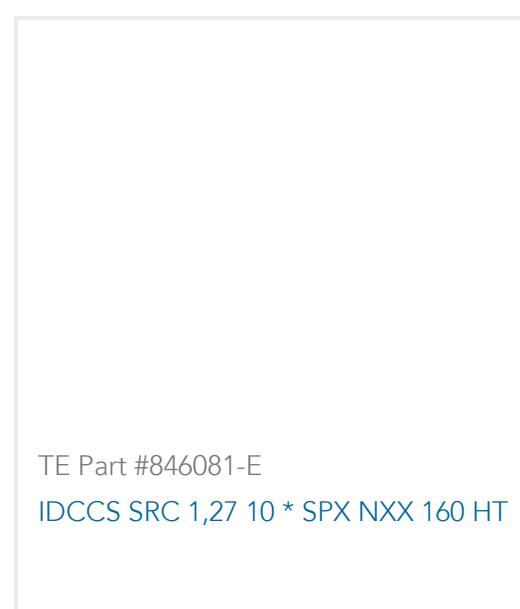
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



Customers Also Bought



Documents

Product Drawings

CONNECTOR ASSY, HIGH CURRENT CARD EDGE,

English

CAD Files

Customer View Model

[ENG_CVM_CVM_1761468-1_B.2d_dxf.zip](#)

English

[3D PDF](#)



3D

Customer View Model

[ENG_CVM_CVM_1761468-1_B.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_1761468-1_B.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Product Specifications

[Application Specification](#)

English